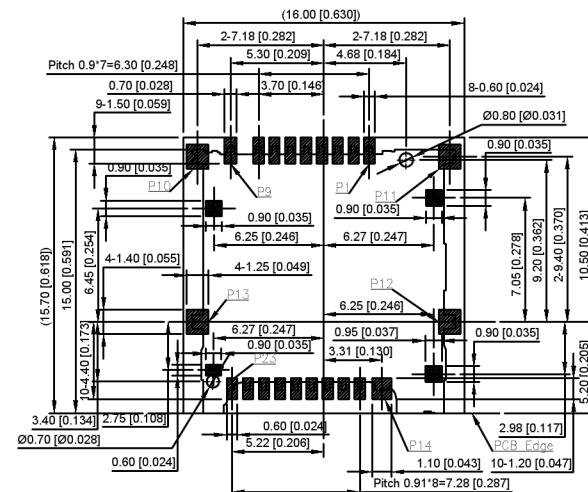
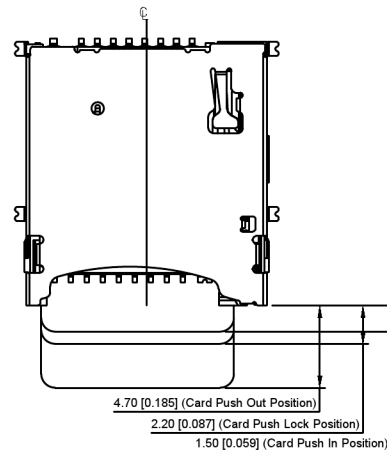
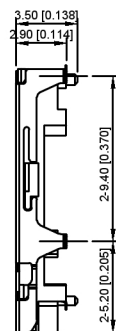
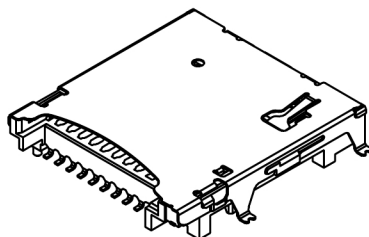
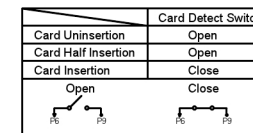
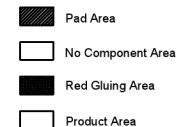




XKB® Connectivity



Note:

1. 材料

1.材料 Material:

1-1. 塑料 Plastic:LCP, S470, Black, UL94V-0

1-2. 触点 Contact: C5210-H

1-3. 外壳 Shell:SUS304-H

2. 电镀 Plating:

2-1. 触点 Contact:

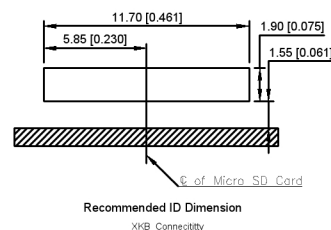
触点 Contact Area: Au 1u"min. Plating Over Ni 50u"min.

焊尾 Solder tail: Plating Over G/F" min.

2-2. 外壳 Shell:

Solderability Ni 50u"min. Over All

3. Contact And Tail Coplanarity To Be 0.10mm max.



XKB Connectivity

Pin No	Pin Assignment
P1	Micro SD DAT2
P2	Micro SD CD/DAT3
P3	Micro SD CMD
P4	Micro SD VDD1
P5	Micro SD CLK
P6	Micro SD VSS
P7	Micro SD DAT0/CLK
P8	Micro SD DAT1/CLK
P9	Micro SD CD
P10	GND
P11	GND
P12	GND
P13	GND
P14	GND
P15	Micro SD VDD2
P16	Micro SD SWIO
P17	Micro SD VSS
P18	Micro SD D0-
P19	Micro SD D0+
P20	Micro SD VSS
P21	Micro SD DI-
P22	Micro SD DI+
P23	Micro SD VSS

生				日期								ANGLAR		±5°		DSND				DATE				SCALE: N/A		MODEL TYPE: TF CARD CONN	
效												L ≤ 4		±0.2		DWN				DATE				VIEW: 		PART NO.:	
ΔX												4<L ≤ 16		±0.3		CHKD				DATE				UNIT: mm/in		DWG NO.:	
ΔX		文件工程章										16<L ≤ 63		±0.4		APPD				DATE				SIZE: A4		XKTF-1152-1	
ΔX												L > 63		±0.5													
MARK		DESCRIPTION				DATE		REVISED		APPROVED				UNSPECIFIED TOLERANCES		XKB INDUSTRIAL PRECISION CO.,LIMITED											
REVISIONS																											
www.xk-dg.cn www.helloxkb.com www.helloxkb.cn																											
																WEIGHT		SHEET		REVISION							
																1.0g		1/1		A0							